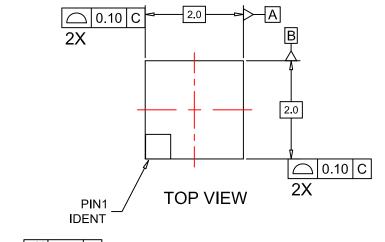
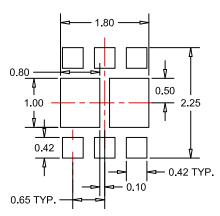
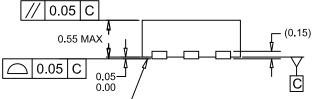
UDFN6 2x2, 0.65P CASE 517DU ISSUE O

DATE 31 OCT 2016



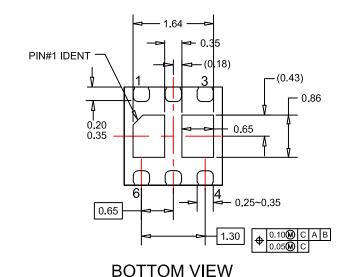




SEATING

PLANE

RECOMMENDED LAND PATTERN



SIDE VIEW

NOTES:

- A. NO JEDEC STANDARD APPLIES
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

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